



S/N 10/027442

PATENT

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Stephen W. Montgomery et al.	Examiner:	Unknown
Serial No.:	10/027442	Group Art Unit:	2835
Filed:	December 20, 2001	Docket:	884.425US1
Title:	ALIGNED CARBON NANOTUBE THERMAL INTERFACE MATERIAL		

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 *et. seq.*, the enclosed materials are brought to the attention of the Examiner for consideration in connection with the above-identified patent application. Applicants respectfully request that this Supplemental Information Disclosure Statement be entered and the documents listed on the attached Form 1449 be considered by the Examiner and made of record. Pursuant to the provisions of MPEP 609, Applicants request that a copy of the 1449 form, initialed as being considered by the Examiner, be returned to the Applicants with the next official communication.

Pursuant to 37 C.F.R. §1.97(b), it is believed that no fee or statement is required with the Supplemental Information Disclosure Statement. However, if an Office Action on the merits has been mailed, the Commissioner is hereby authorized to charge the required fees to Deposit Account No. 19-0743 in order to have this Supplemental Information Disclosure Statement considered.

The Examiner is invited to contact the Applicants' Representative at the below-listed telephone number if there are any questions regarding this communication.

Respectfully submitted,

STEPHEN W. MONTGOMERY ET AL.

By their Representatives,

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Date

April 25, 2003

By

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MAY - 2 2003
TECHNOLOGY CENTER 2800

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner of Patents, Washington, D.C. 20231, on this 28th day of April, 2003

Chris Hammond
Name

Signature